

MOSFET – Single N-Channel

150 V, 4.4 mΩ, 187 A

NTBLS4D0N15MC

Features

- Low $R_{DS(on)}$ to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- Lowers Switching Noise/EMI
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Power Tools, Battery Operated Vacuums
- UAV/Drones, Material Handling
- BMS/Storage, Home Automation

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter			Value	Unit
V_{DSS}	Drain-to-Source Voltage			150	V
V_{GS}	Gate-to-Source Voltage			± 20	V
I_D	Continuous Drain Current $R_{\theta JC}$ (Note 2)	Steady State	$T_C = 25^\circ\text{C}$	187	A
P_D	Power Dissipation $R_{\theta JC}$ (Note 2)			316	W
I_D	Continuous Drain Current $R_{\theta JA}$ (Notes 1, 2)	Steady State	$T_A = 25^\circ\text{C}$	19	A
P_D	Power Dissipation $R_{\theta JA}$ (Notes 1, 2)			3.4	W
I_{DM}	Pulsed Drain Current	$T_A = 25^\circ\text{C}$, $t_p = 10\ \mu\text{s}$		2255	A
T_J , T_{stg}	Operating Junction and Storage Temperature Range			-55 to 175	°C
I_S	Source Current (Body Diode)			263	A
E_{AS}	Single Pulse Drain-to-Source Avalanche Energy ($I_L = 81.5\ A_{pk}$, $L = 0.1\ \text{mH}$)			332	mJ
T_L	Lead Temperature Soldering Reflow for Soldering Purposes (1/8" from case for 10 s)			260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

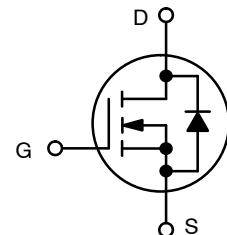
1. Surface-mounted on FR4 board using 1 in² pad size, 1 oz Cu pad.
2. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

ON

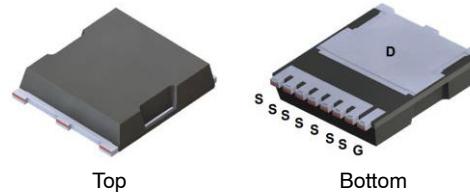
ON Semiconductor®

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$V_{(BR)DSS}$	$R_{DS(ON)}\text{ MAX}$	$I_D\text{ MAX}$
150 V	4.4 mΩ @ 10 V	187 A
	4.9 mΩ @ 8 V	

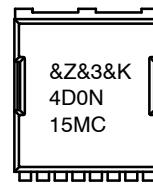


N-CHANNEL MOSFET



H-PSOF8L 11.68x9.80
MO-299A
CASE 100CU

MARKING DIAGRAM



&Z = Assembly Plant Code
&3 = Numeric Date Code
&K = Lot Code
4D0N15MC = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping [†]
NTBLS4D0N15MC	MO-299A (Pb-Free)	2000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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THERMAL RESISTANCE RATINGS

Symbol	Parameter	Max	Unit
$R_{\theta JC}$	Junction-to-Case – Steady State (Note 2)	0.5	$^{\circ}\text{C}/\text{W}$
$R_{\theta JA}$	Junction-to-Ambient – Steady State (Note 2)	43	

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$	150	–	–	V
$V_{(\text{BR})\text{DSS}} / T_J$	Drain-to-Source Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, ref to 25°C	–	30.23	–	$\text{mV}/^{\circ}\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{GS}} = 0 \text{ V}$, $V_{\text{DS}} = 120 \text{ V}$	$T_J = 25^{\circ}\text{C}$	–	1	μA
			$T_J = 125^{\circ}\text{C}$	–	10	μA
I_{GSS}	Gate-to-Source Leakage Current	$V_{\text{DS}} = 0 \text{ V}$, $V_{\text{GS}} = \pm 20 \text{ V}$	–	–	± 100	nA

ON CHARACTERISTICS

$V_{\text{GS}(\text{TH})}$	Gate Threshold Voltage	$V_{\text{GS}} = V_{\text{DS}}$, $I_D = 584 \mu\text{A}$	2.5	3.7	4.5	V
$V_{\text{GS}(\text{TH})} / T_J$	Negative Threshold Temperature Coefficient	$I_D = 250 \mu\text{A}$, ref to 25°C	–	-10.12	–	$\text{mV}/^{\circ}\text{C}$
$R_{\text{DS}(\text{on})}$	Drain-to-Source On Resistance	$V_{\text{GS}} = 10 \text{ V}$, $I_D = 80 \text{ A}$	–	3.1	4.4	$\text{m}\Omega$
		$V_{\text{GS}} = 8 \text{ V}$, $I_D = 53 \text{ A}$	–	3.5	4.9	
g_{FS}	Forward Transconductance	$V_{\text{DS}} = 5 \text{ V}$, $I_D = 80 \text{ A}$	–	174	–	S
R_G	Gate-Resistance	$T_A = 25^{\circ}\text{C}$	–	1.3	–	Ω

CHARGES & CAPACITANCES

C_{iss}	Input Capacitance	$V_{\text{GS}} = 0 \text{ V}$, $f = 1 \text{ MHz}$, $V_{\text{DS}} = 75 \text{ V}$	–	7490	–	pF
C_{oss}	Output Capacitance		–	2055	–	
C_{rss}	Reverse Transfer Capacitance		–	27.2	–	
$Q_{\text{G}(\text{TOT})}$	Total Gate Charge	$V_{\text{GS}} = 10 \text{ V}$, $V_{\text{DS}} = 75 \text{ V}$, $I_D = 80 \text{ A}$	–	90.4	–	nC
$Q_{\text{G}(\text{TH})}$	Threshold Gate Charge		–	24.7	–	
Q_{GS}	Gate-to-Source Charge		–	40.2	–	
Q_{GD}	Gate-to-Drain Charge		–	12.6	–	
V_{GP}	Plateau Voltage		–	5.7	–	V
Q_{oss}	Output Charge	$V_{\text{GS}} = 0 \text{ V}$, $V_{\text{DS}} = 75 \text{ V}$	–	251	–	nC

SWITCHING CHARACTERISTICS, $V_{\text{GS}} = 10 \text{ V}$ (Note 3)

$t_{\text{d}(\text{ON})}$	Turn-On Delay Time	$V_{\text{GS}} = 10 \text{ V}$, $V_{\text{DS}} = 75 \text{ V}$, $I_D = 80 \text{ A}$, $R_G = 6 \Omega$	–	47	–	ns
t_r	Rise Time		–	115	–	
$t_{\text{d}(\text{OFF})}$	Turn-Off Delay Time		–	58	–	
t_f	Fall Time		–	11	–	

DRAIN-SOURCE DIODE CHARACTERISTICS

V_{SD}	Forward Diode Voltage	$V_{\text{GS}} = 0 \text{ V}$, $I_S = 80 \text{ A}$	$T_J = 25^{\circ}\text{C}$	–	0.86	1.2	V
			$T_J = 125^{\circ}\text{C}$	–	0.75	–	

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ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted) (continued)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
t _{RR}	Reverse Recovery Time	V _{GS} = 0 V, dI _S /dt = 100 A/μs, I _S = 80 A	–	84	–	ns
t _a	Charge Time		–	55	–	
t _b	Discharge Time		–	29	–	
Q _{RR}	Reverse Recovery Charge		–	180	–	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Switching characteristics are independent of operating junction temperatures

TYPICAL CHARACTERISTICS

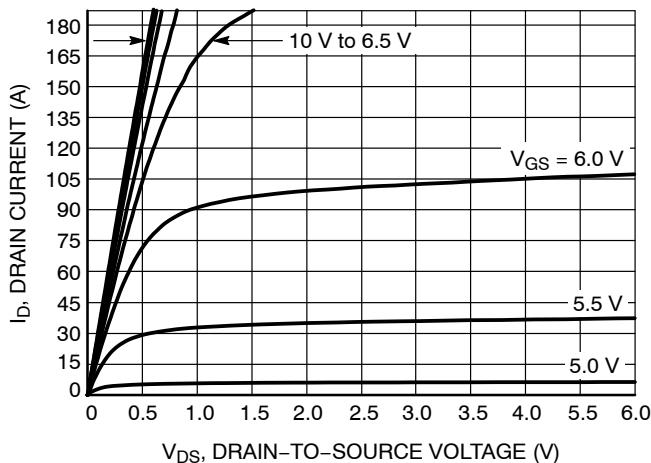


Figure 1. On-Region Characteristics

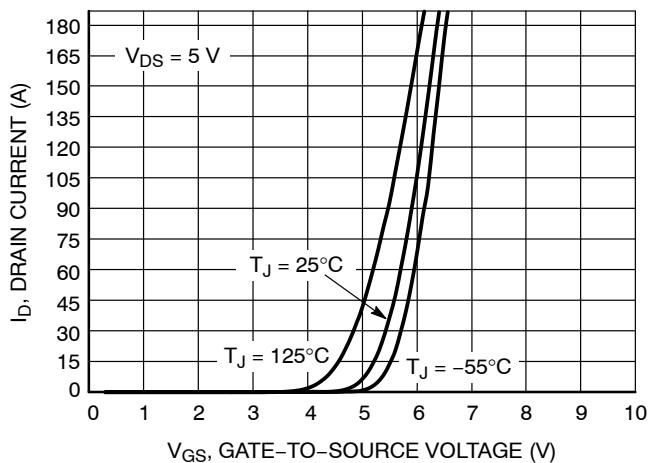


Figure 2. Transfer Characteristics

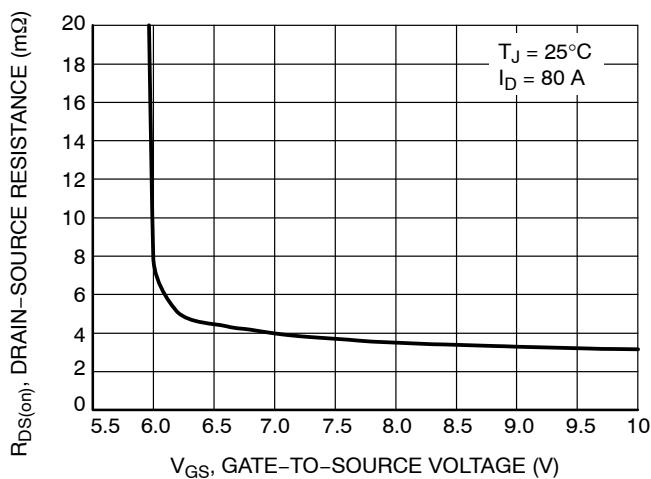


Figure 3. On-Resistance vs. V_{GS}

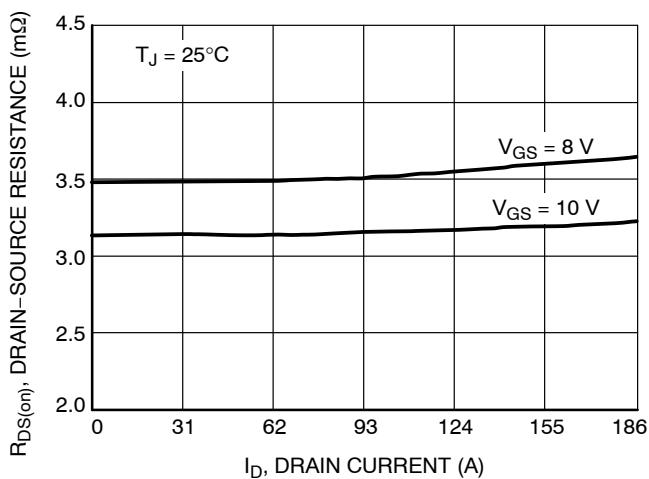


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

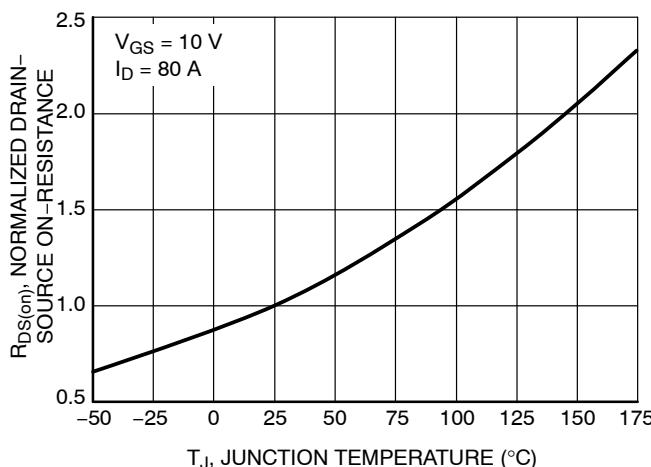


Figure 5. On-Resistance Variation with Temperature

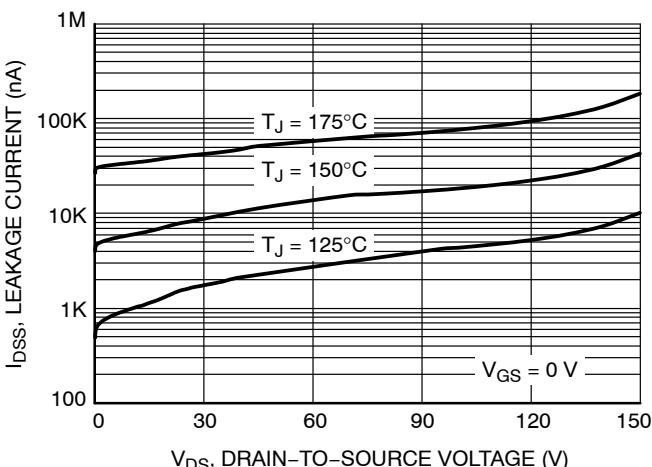
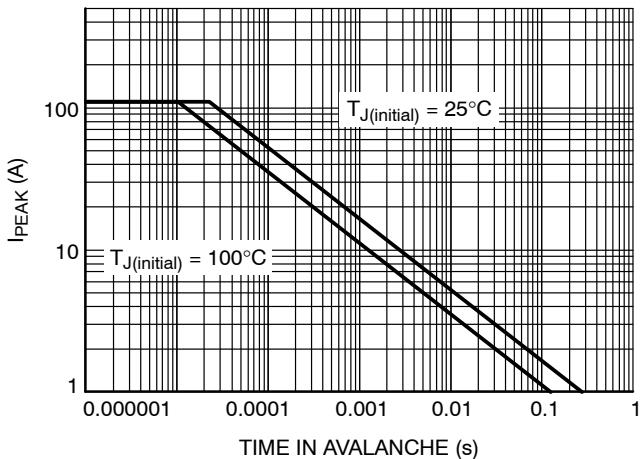
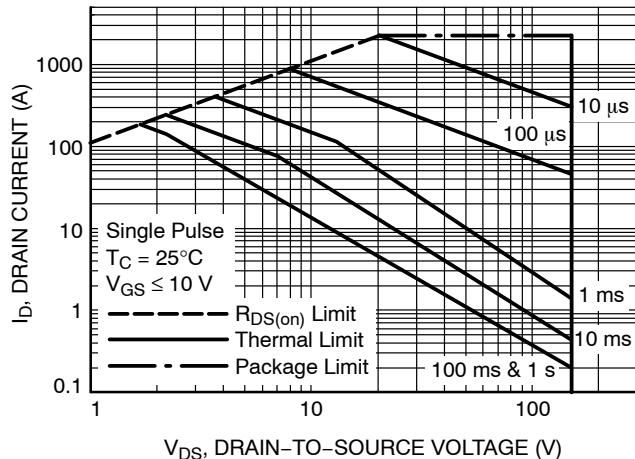
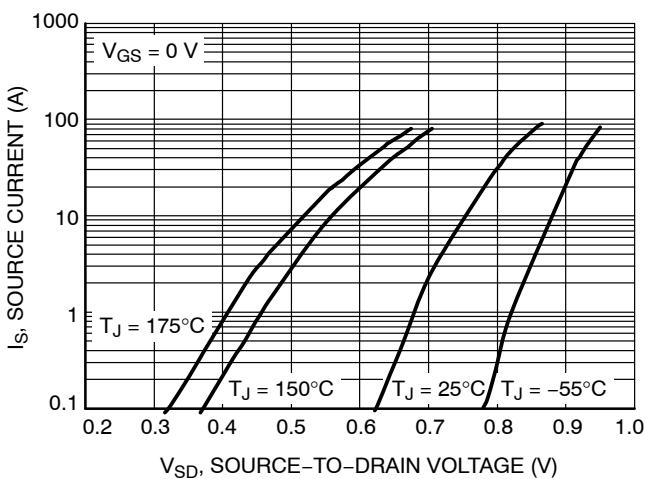
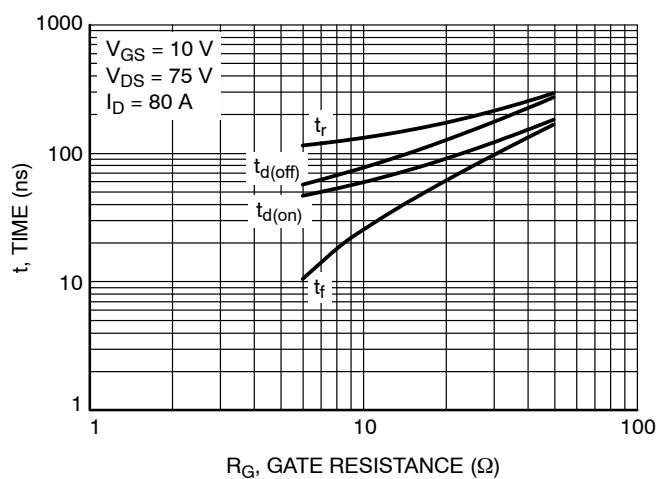
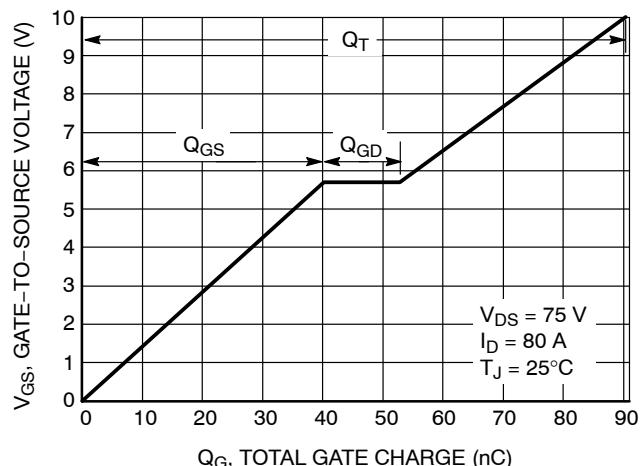
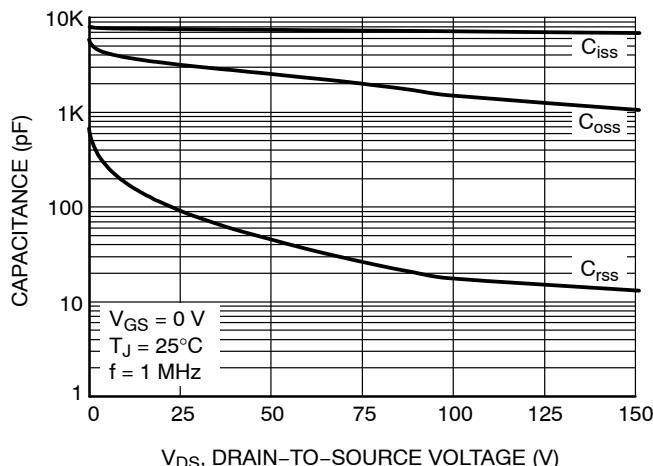


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS

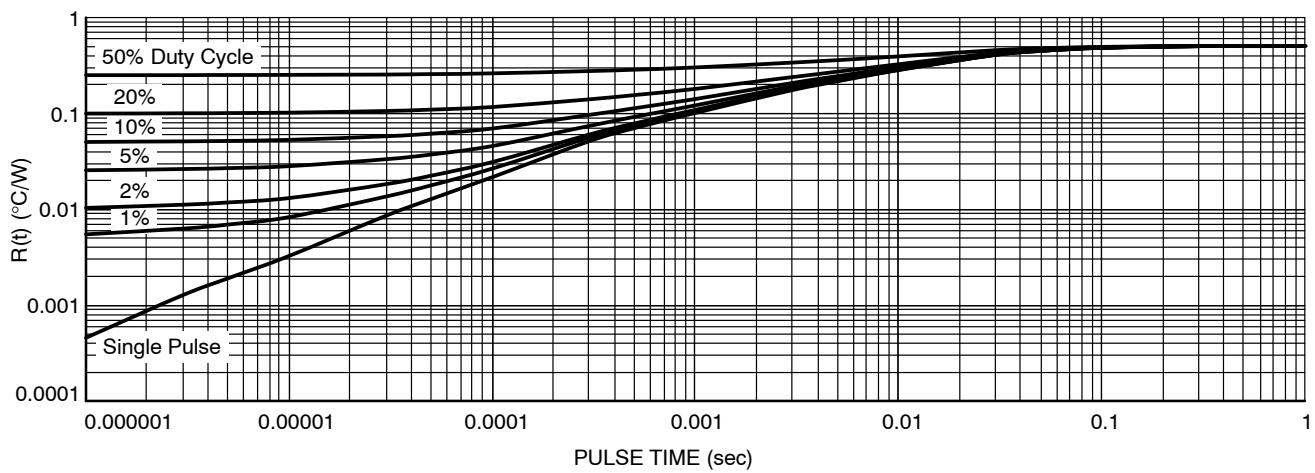


Figure 13. Thermal Characteristics (Junction-to-Ambient)

MECHANICAL CASE OUTLINE

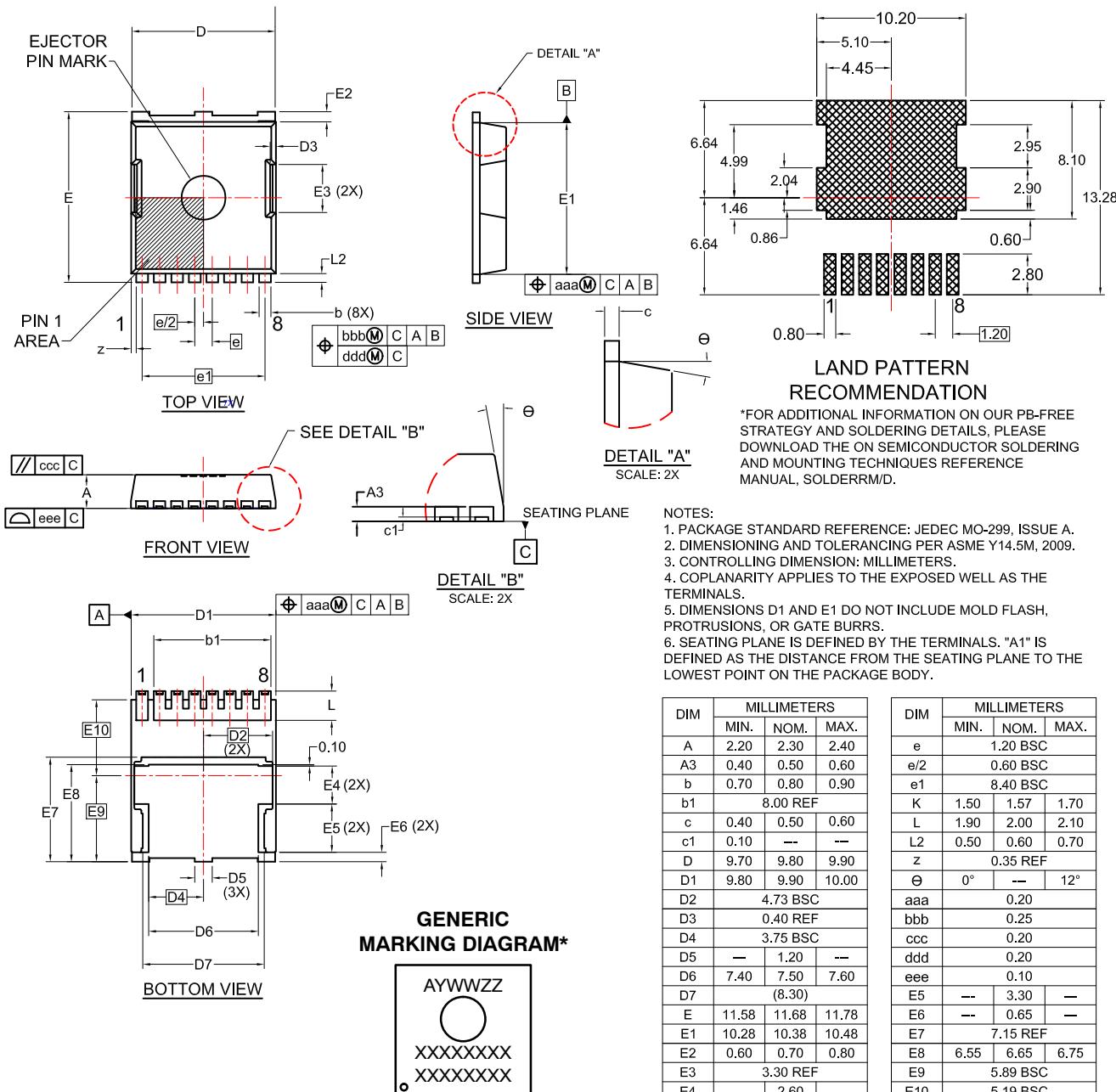
PACKAGE DIMENSIONS

ON Semiconductor®



H-PSOF8L 11.68x9.80
CASE 100CU
ISSUE A

DATE 06 JAN 2020



*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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